

인덕션 히팅 해석의 최신 기술 (Induction Heating)

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Manufacturing



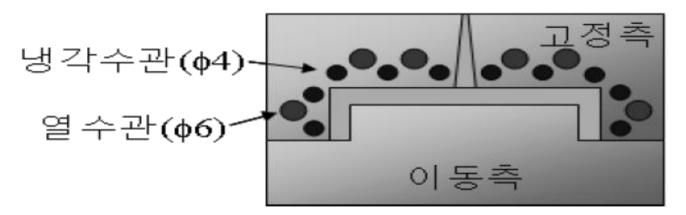
- 급열급냉(Rapid Heat & Cool Molding)의 이란?
- RHCM 공정의 기본 원리는 수지가 금형 내부로 주입이 될 때 금형 온도를 급속 가열하여 열변형 온도 이상을 유지하고, 보압 및 냉각 공정에서는 제품의 고화를 촉진하기 위하여 금형의 온도를 급격히 떨어뜨리는 방식이다.
- 주요 목적은 제품의 외관 특성(웰드라인, 고광택)을 개선하고자 하는 성형가공 기술이다.



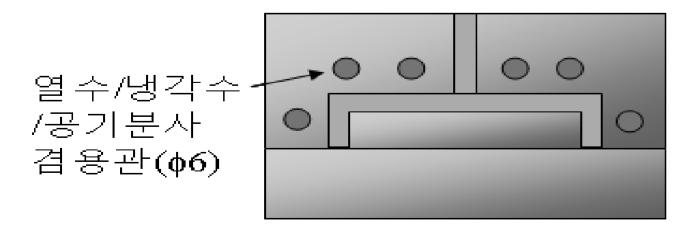


급열급냉(Rapid Heat & Cool Molding)의 종류

RHCM (Rapid Heat & Cool Molding)



열수관과 냉각수관이 분리 열효율측면에서 매우 비효율적



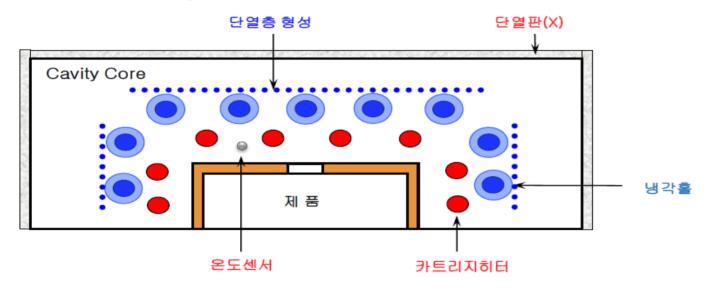
열수/냉각수/공기분사 겸용관을 이용 – Moldflow RHCM 해석



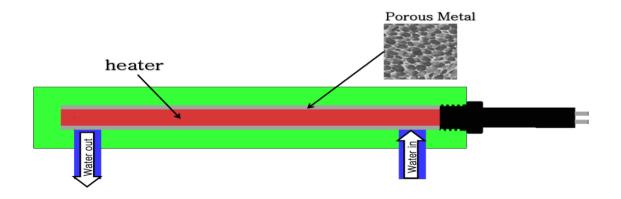


■ 급열급냉(Rapid Heat & Cool Molding)의 종류

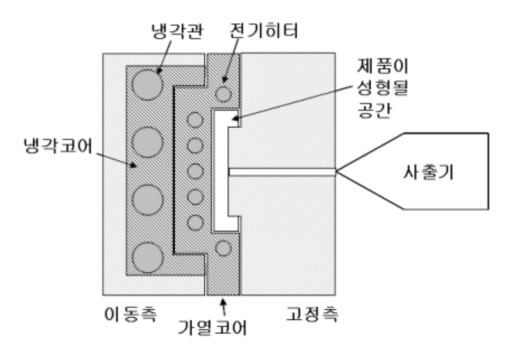
Electricity RHCM Mold



F-Mold



E-Mold







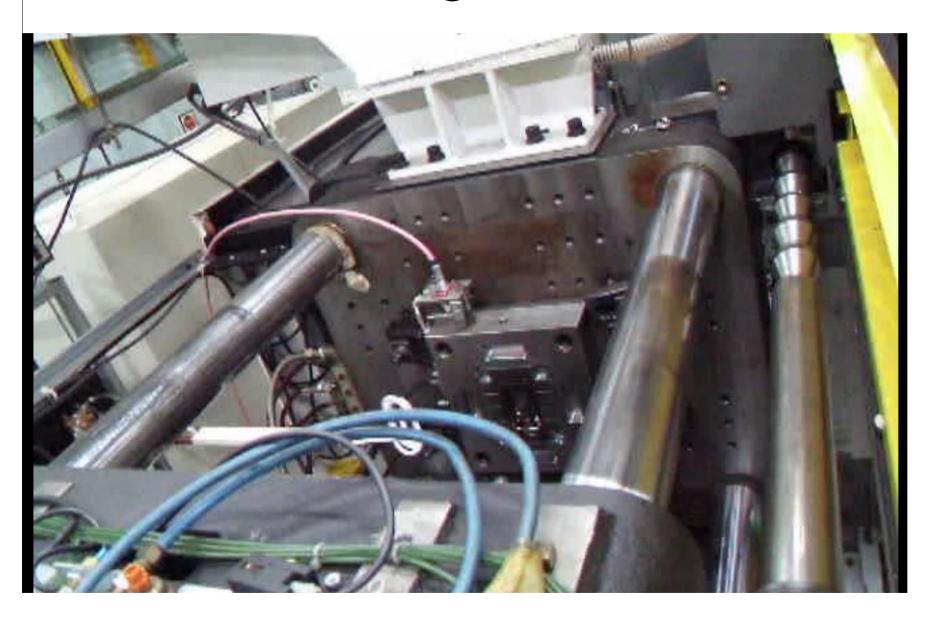
Induction Heating 소개







Induction Heating 소개













At the end of this class, you will be able to:

- Induction Heating 해석 방법을 익힘
 - ▶ 전기저항력의 개념은 알게 됨.
 - 투자율 or 상대투자율의 개념을 알게 됨.
- Induction Heating의 해석결과 확인



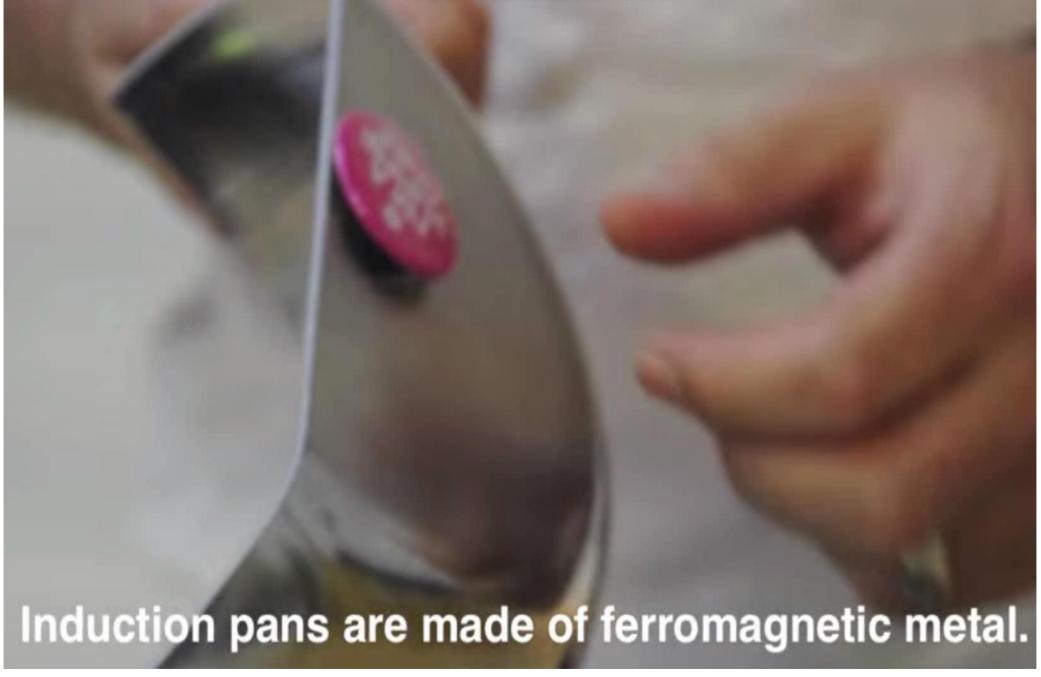


Induction Heating 소개





1. Induction Heating 의 예





Gold Partner
Manufacturing



1. Red-hot ice cube by induction heating



Product Support Specialized Authorized Developer Authorized Certification Center Authorized Training Center





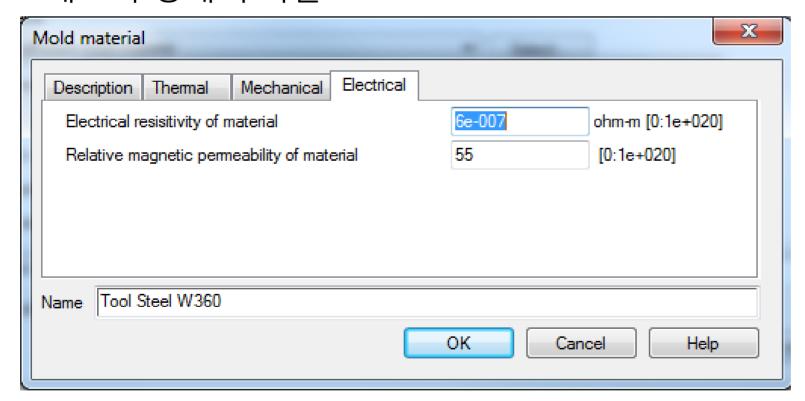


1. Electrical 이란?

Electrical resistivity of material(단위: ohm-m)

재료의 전기저항률: 단위 길이를 갖는 물체 또는 어떤 물체의 단위 용적(1cm^3)의 전기저항

Relative magnetic permeability of material 재료의 상대 투자율







1. 재료의 전기저항률(Electrical resistivity of material)이란? 어떤 물체가 전기를 흐름성을 비교하기 위한 물성수치(단위: Ωm) → 전기저항률이 낮을수록 전기는 흐르기 쉽다.

=	¦속
Metal	ls (Ωm)
CI I.	. 140 8
• Steel, low c	arbon 142e ⁻⁸
 Titanium 	42.0e ⁻⁸
D1 (*	10.60 %
 Platinum 	10.60e ⁻⁸
 Nickel 	6.84e ⁻⁸
	2.65 0
 Aluminum 	2.65e ⁻⁸
• Gold	2.35~2.65e ⁻⁸
 Copper 	1.67~2.65e ⁻⁸
• Silver	1.59e ⁻⁸
3	
저기되하르차그. b	ttp://www.roado.com/

반도체 Semiconductors GaAs • Silicon (pure) • Silicon (.0025 ohm-cm) Silicon Dioxide (amorphous) • Silicon Nitride .16 - .33 Silicon Carbide

절연체 **Insulators** Diamond Epoxy Glass water Liquid Nitrogen(77K) Liquid Argon(85K)

• Air

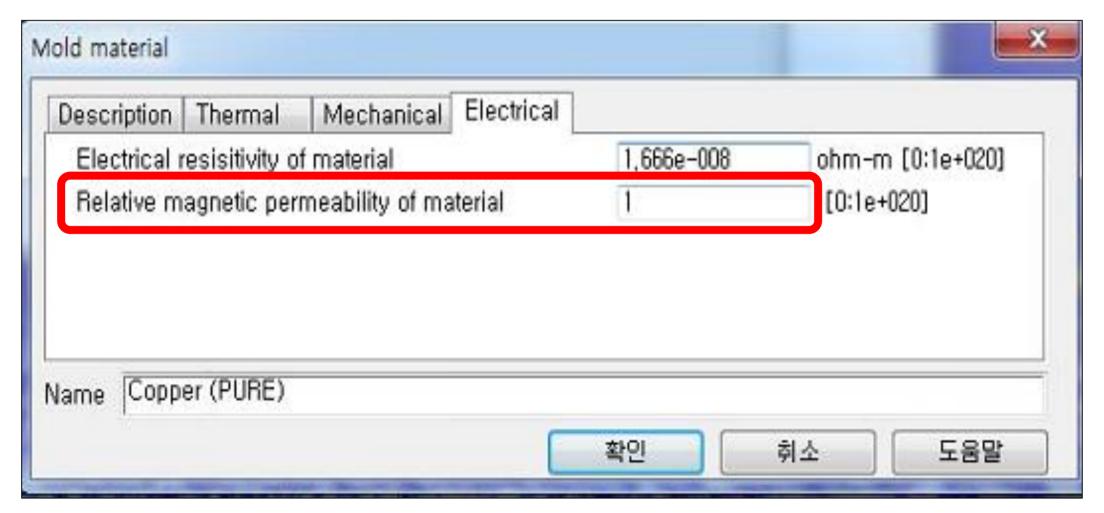
전기저항률참고: http://www.reade.com/Particle Briefings/elec res.html http://www.matweb.com/



1. 재료의 **상대 투자율** (Relative magnetic permeability of material)?

magnetic permeability = 투자율 = 透 투과하다(투) 磁 자석(자) 率 비율(율)

상대 투자율 μ_r = 물질의 투자율 μ / 진공의 투자율 μ_0







1. 재료의 **상대 투자율**

(Relative magnetic permeability of material)?

상대 투자율 = 물질의 투자율 / 진공의 투자율

물질 투자율

물질의 자기적 성질을 나타내는 양 물질의 종류에 따라 달라진다. 강자성체 > 1 (철, 코발트, 니켈 종류의 원소 또는 합금) 상자성체 = 1 (산화알미늄...) 반자성체 < 1 (구리, 안티몬, 물...)

진공 투자율

물질이 진공 환경에서 자기적 성질을 나타내는 양 매우 작은 값으로 거의 0에 가깝다. (μ 진공 = $4\pi \times 10-7 \approx 1.26 \times 10-6 \text{ H·m}^{-1}$)

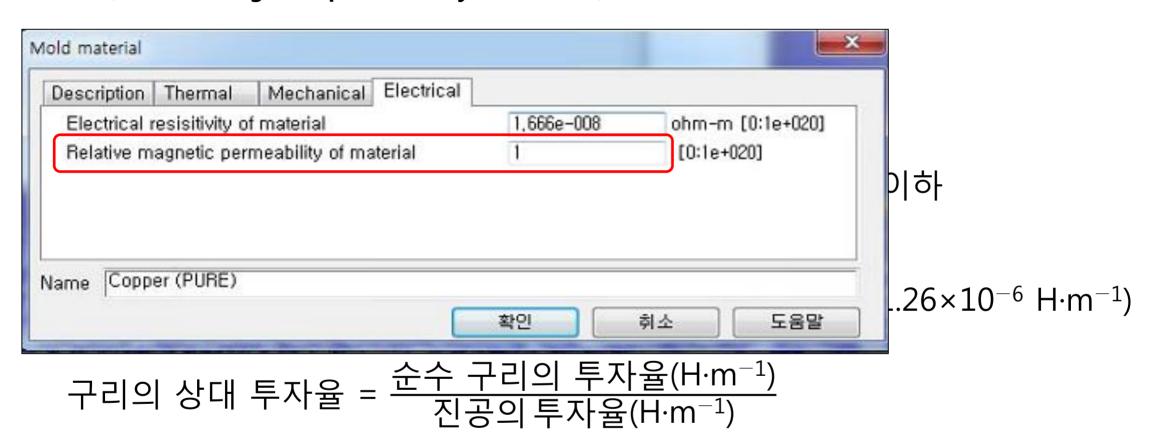
자기장: 자석이나 전류, 변화하는 전기장 등의 주위에 자기력이 작용하는 공간.





1. 재료의 **상대 투자율**

(Relative magnetic permeability of material)?



$$= \frac{1.2566368 \times 10 - 6}{4\pi \times 10 - 7} = 0.999999791955 = 1$$

자기장의 세기 H [단위(A/m)]

재료의 투자율 확인: http://en.wikipedia.org/wiki/Permeability_(electromagnetism)
자기장: http://ko.wikipedia.org/wiki/%EC%9E%90%EA%B8%B0%EC%9E%A516



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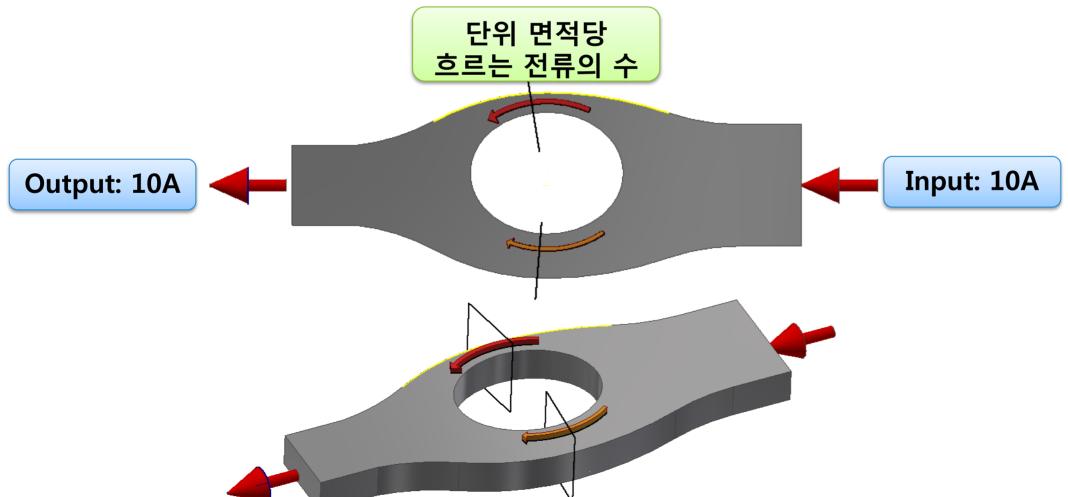


1. 재료의 상대 투자율
(Relative magnetic permeability of material)?

자력선속밀도: 단위 면적을 수직으로 지나는 자기력선의 수, 이를 자속밀도 $Wb/m^2 = N/(Am)$ [단위: 국제단위계 가우스(G), CGS 테슬라(T)]

전류 밀도 = $\frac{A}{m^2}$ \propto 자속 밀도 = $\frac{Wb}{m^2}$

단위 면적당 흐르는 전류 < 단위 면적당 흐르는 자기력



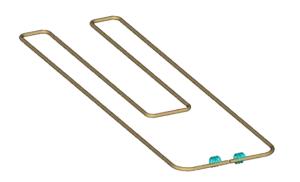


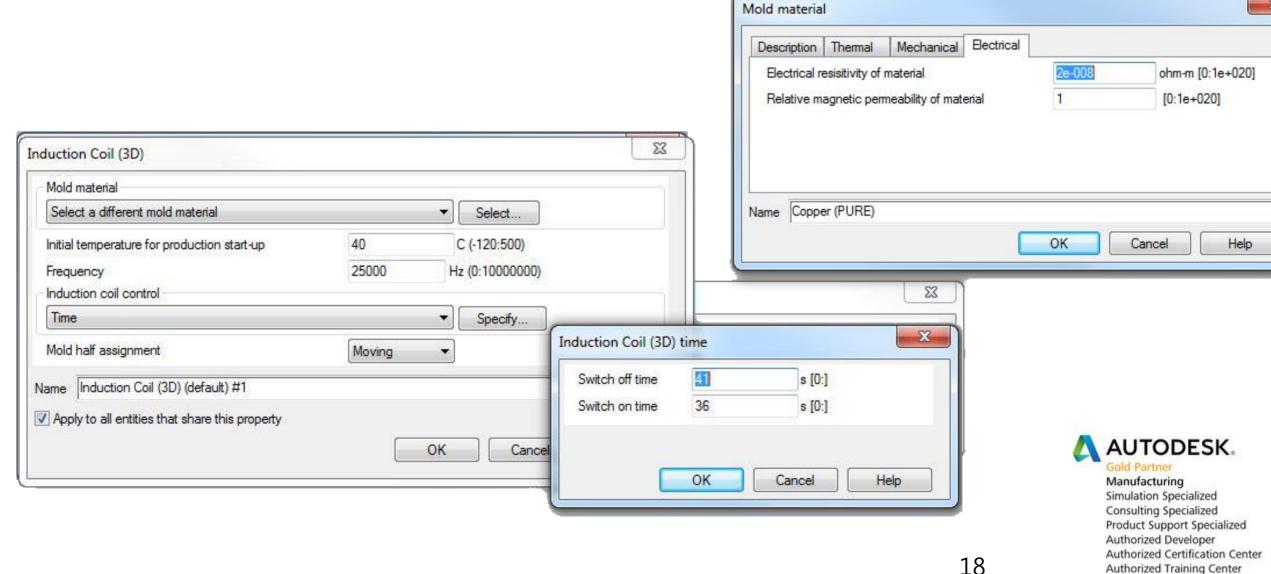
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전류 밀도: http://ko.wikipedia.org/wiki/%EC%A0%84%EB%A5%98_%EB%B0%80%EB%8F%84 17



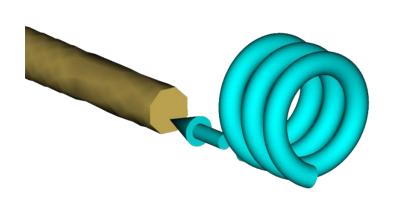
1. Elemental properties는 Coil로 지정 해야 함. 유도가열을 목적으로 하는 coil은 동을 추천

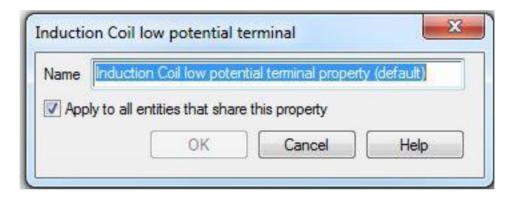


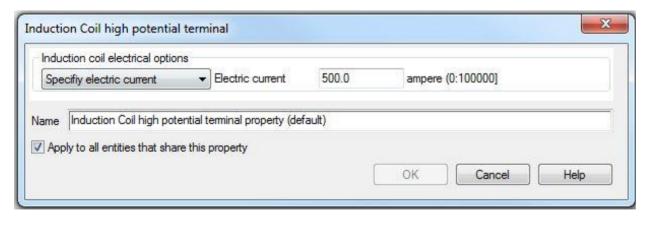


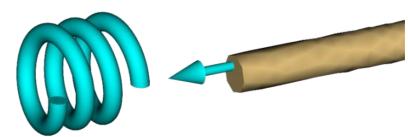


1. 전류 또는 전압의 크기 지정.(전류의 방향)











- Induction heating 해석에서 신뢰도를 높이기 위한 도체의 매싱 기법
- 유도전류의 86%가 도체 표면 레이어에 집중되어 있음.
- (최외곽 표면층의 두께) $\delta = \frac{1}{\sqrt{\pi f \mu \sigma}}$

f: 발전기의 주파수(s⁻¹),

 μ : 재료의 투자율(H・m⁻¹ = kg・m²・s⁻²・A⁻²・m⁻¹),

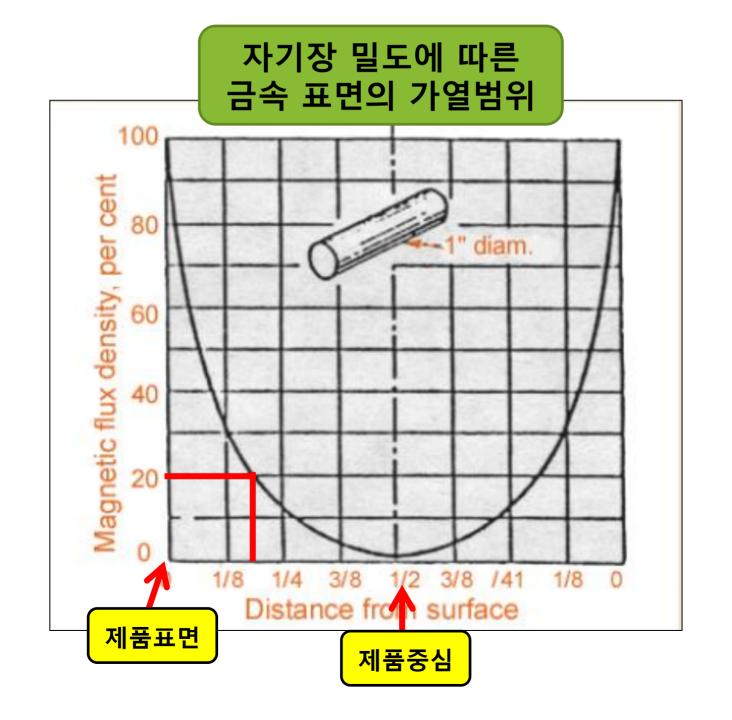
σ: 재료의 전기 전도율 (S·m⁻¹=kg⁻¹·m⁻²·s³·A²·m⁻¹)

도움말 참고« meshing guidelines for induction heating »





• 해석 신뢰도를 높이기 위해 Mold Insert(가열체)의 1^{st} layer 두께는 $\delta(델타)$ 가 중요한 이유는?





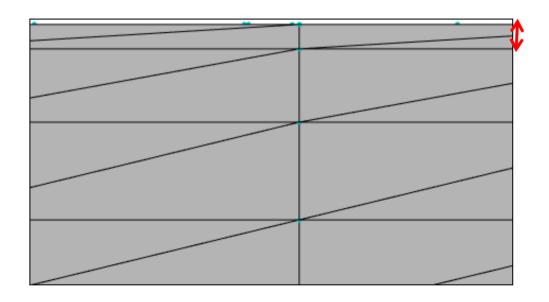


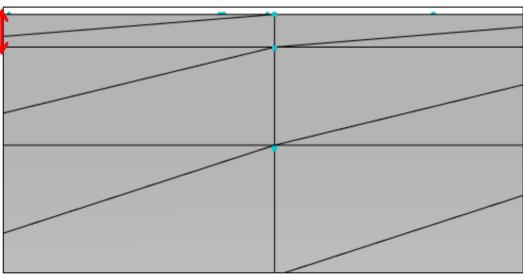
- Meshing 고려대상
 - Mold Insert(가열체)
- Mold Insert(가열체)표면 Mesh size
 - $mesh\ size = \frac{\delta}{0.8}$
- Mold Insert(가열체)의 1^{st} layer 두께는 δ (델타) 로 지정
- 표면부위는 4 Layer를 추천함.





1st Layer 두께 사이즈(1st layer 두께 0.2mm / 1mm) General Tetra General Tetra Guidelines Guidelines Minimum number of layers between external Minimum number of layers between external 5 and internal mold surfaces [4:20]: and internal mold surfaces [4:20]: Mesh size gradation ratio from surface Mesh size gradation ratio from surface 1.5 1.5 to interior regions [1.0:1.5]: to interior regions [1.0:1.5]: Ratio of first element layer thickness to local Ratio of first element layer thickness to local 0.2 surface edge length [0.2:1.0]: surface edge length [0.2:1.0]: Number of enhancement layers on mold Number of enhancement layers on mold blocks and mold inserts [0:8]: blocks and mold inserts [0:8]: Scale factor to the thickness of Scale factor to the thickness of 1 enhancement layers [0.5:1.0] enhancement layers [0.5:1.0]





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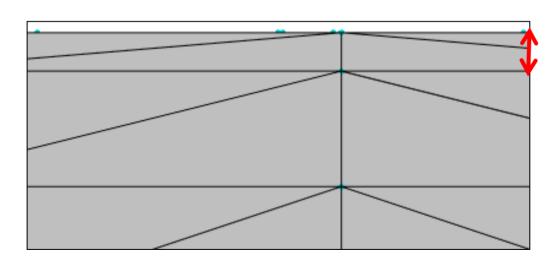
Manufacturing

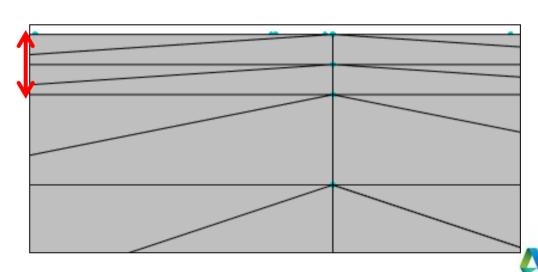


1st Layer 두께의 개수 결정(1st layer 1mm가 1개 / 2개)

General Tetra Guidelines	
Minimum number of layers between external and internal mold surfaces [4:20]:	5
Mesh size gradation ratio from surface to interior regions [1.0:1.5]:	1.5
Ratio of first element layer thickness to local surface edge length [0.2:1,0]:	1
Number of enhancement layers on mold blocks and mold inserts [0:8]:	1
Scale factor to the thickness of enhancement layers [0.5:1.0]	1

General	Tetra	Guidelines		
Minimum number of layers between external and internal mold surfaces [4:20]:			5	
Mesh size gradation ratio from surface to interior regions [1.0:1.5]:			1.5	
Ratio of first element layer thickness to local surface edge length [0.2:1,0]:			1	
Number of enhancement layers on mold 2 blocks and mold inserts [0:8]:			2	
Scale factor to the thickness of enhancement layers [0.5:1.0]				





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1st Layer 두께 사이즈에 Scale 적용 Ex) 1st layer 1mm 일 때 1 / 0.5

Minimum number of layers between external and internal mold surfaces [4:20]:	5
Mesh size gradation ratio from surface to interior regions [1.0:1.5]:	1.5
Ratio of first element layer thickness to local	1
Surface edge length [0.2:1.0]: Number of enhancement layers on mold	2
blocks and mold inserts [0:8]: Scale factor to the thickness of enhancement layers [0.5:1.0]	1

Minimum number of layers between external and internal mold surfaces [4:20]:

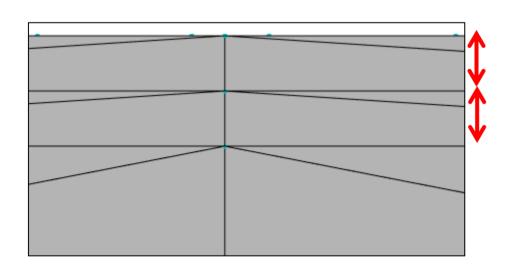
Mesh size gradation ratio from surface to interior regions [1.0:1.5]:

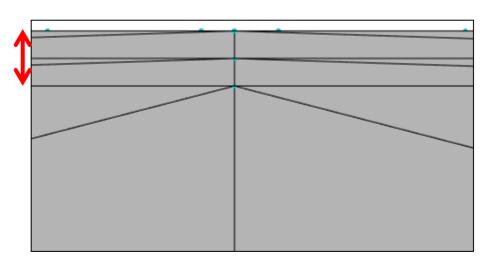
Ratio of first element layer thickness to local surface edge length [0.2:1.0]:

Number of enhancement layers on mold blocks and mold inserts [0:8]:

Scale factor to the thickness of enhancement layers [0.5:1.0]

Scale factor to the thickness of enhancement layers [0.5:1.0]

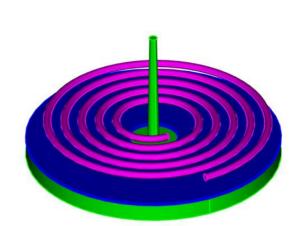


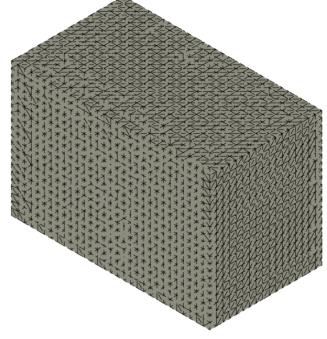






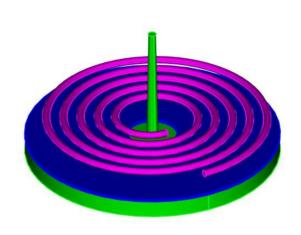
- Mold Surface Wizard(FEM)
 - 1. 제품 모델링
 - 2. Runner 모델링 (Beam or 3D CAD)
 - 3. Channel 모델링 (Beam)
 - 4. Coil 모델링(3D CAD)
 - 5. Insert 모델링(3D CAD)

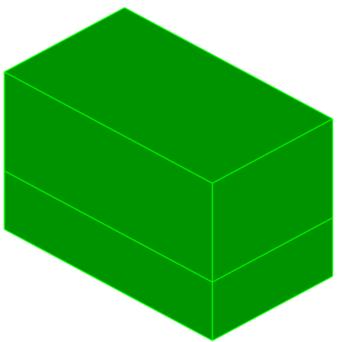




2. Mold Block(FEM)

- 1. 제품 모델링
- 2. Runner 모델링 (Beam or 3D CAD)
- 3. Channel 모델링 (Beam)
- 4. Coil 모델링(3D CAD)
- 5. Insert 모델링(3D CAD)
- 6. 금형 모델링 (3D CAD)

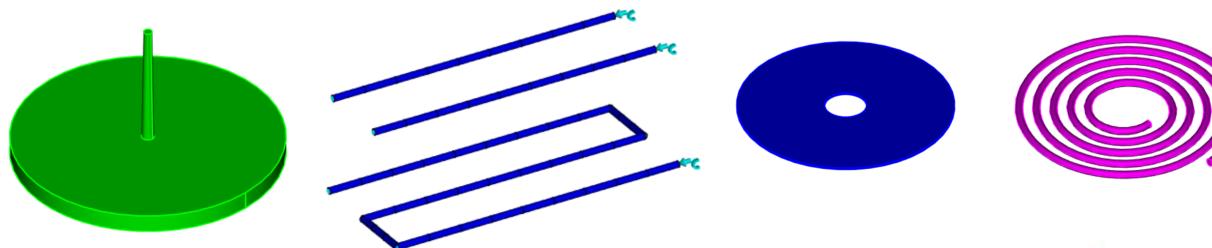




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- 제품 모델링
- Runner 모델링 (Beam or 3D CAD)
- Channel 모델링 (Beam)
- Coil 모델링(3D CAD)
- Insert 모델링(3D CAD)

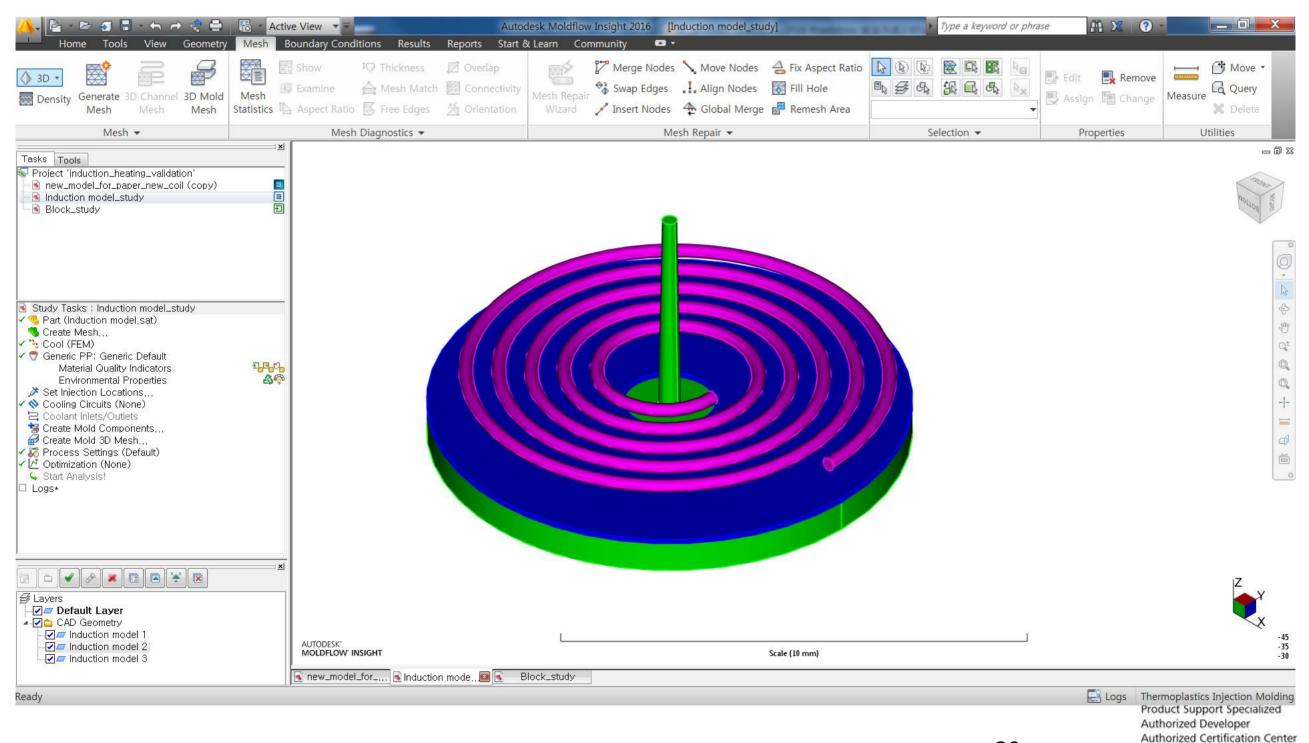




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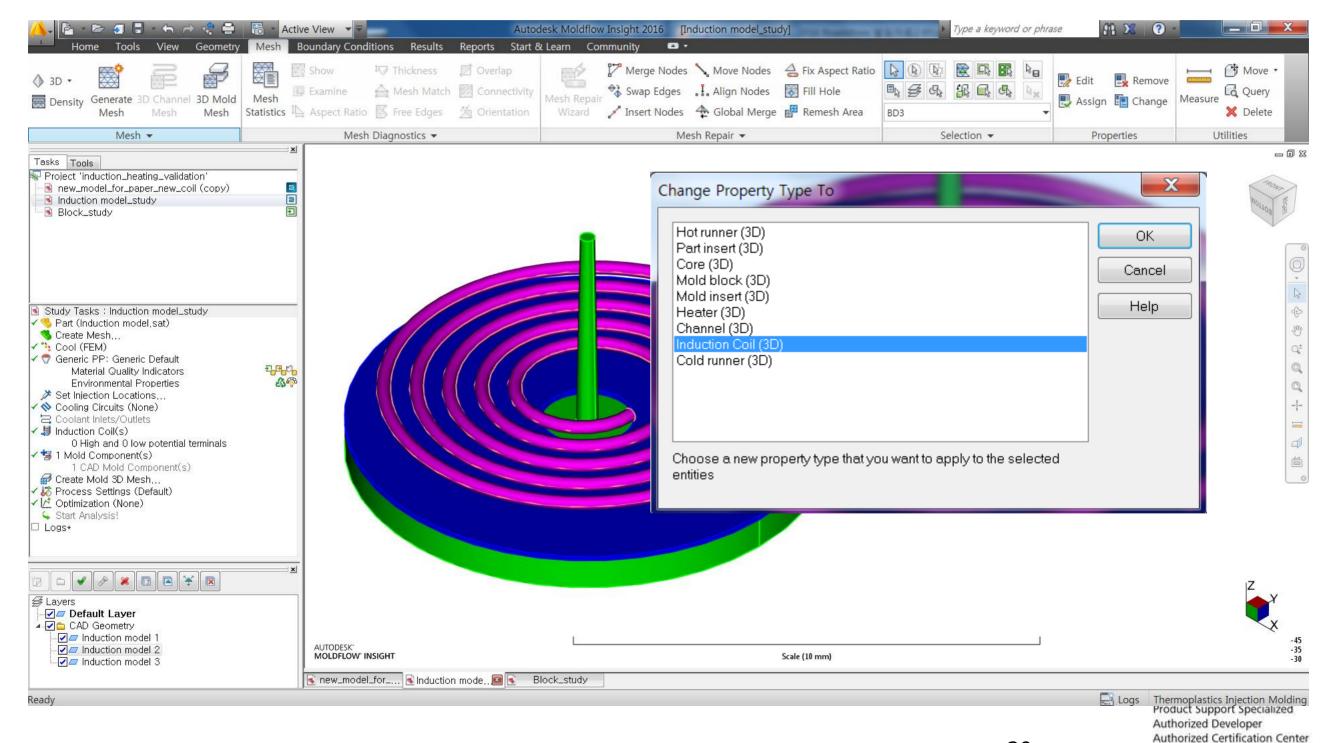


제품, Runner, Coil, Mold insert - Import



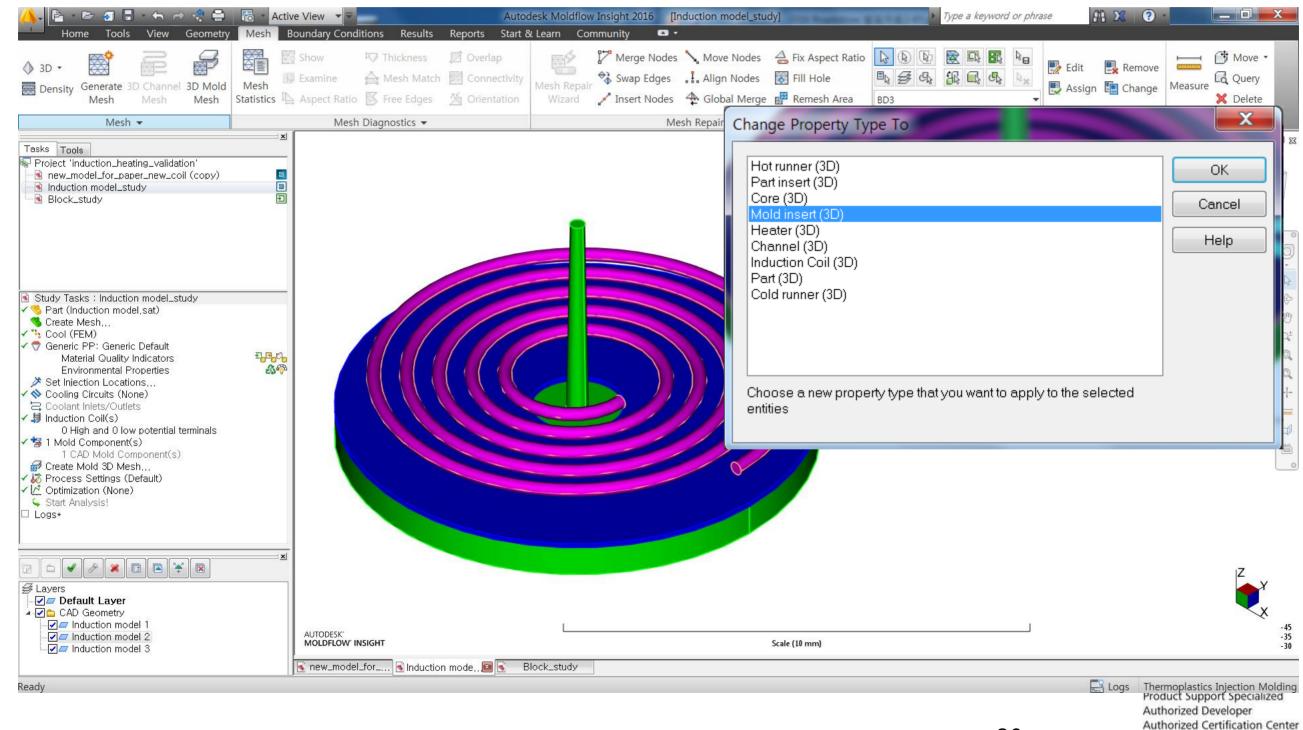


Induction Coil 로 속성 설정



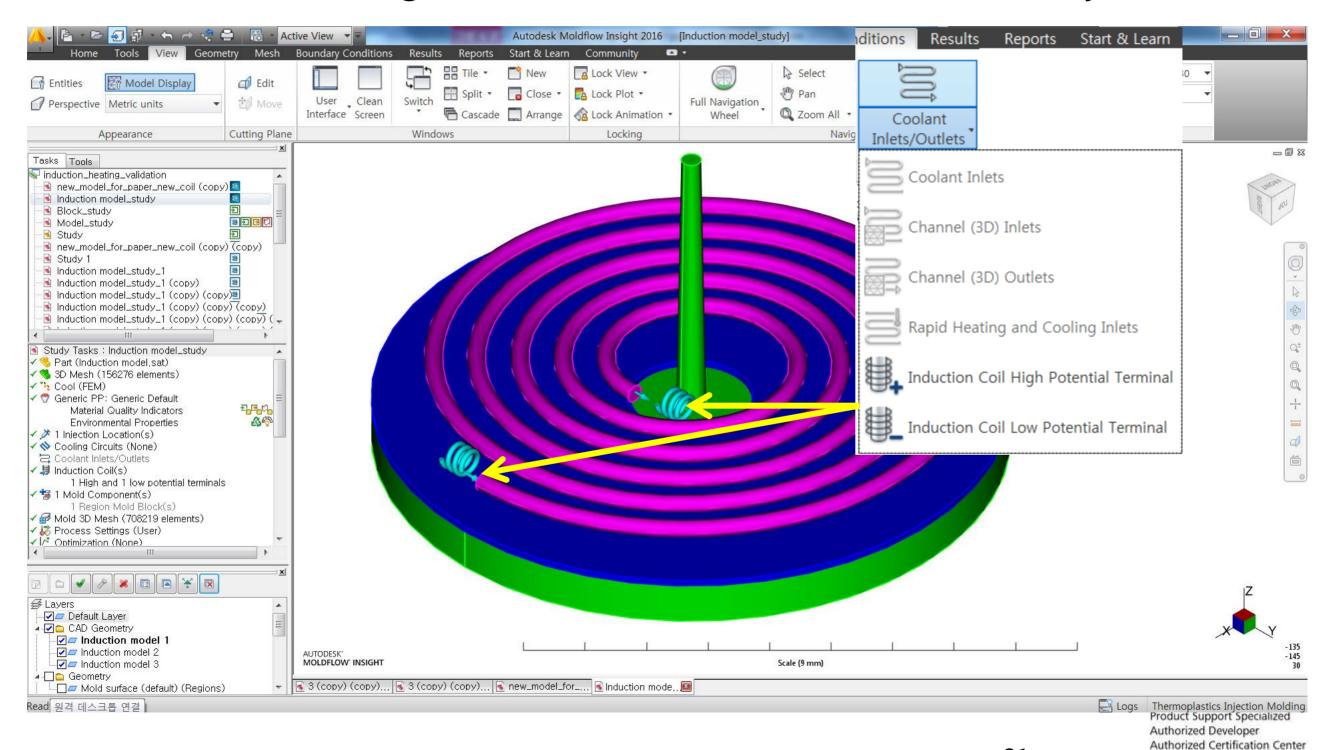


Mold insert 로 속성 설정



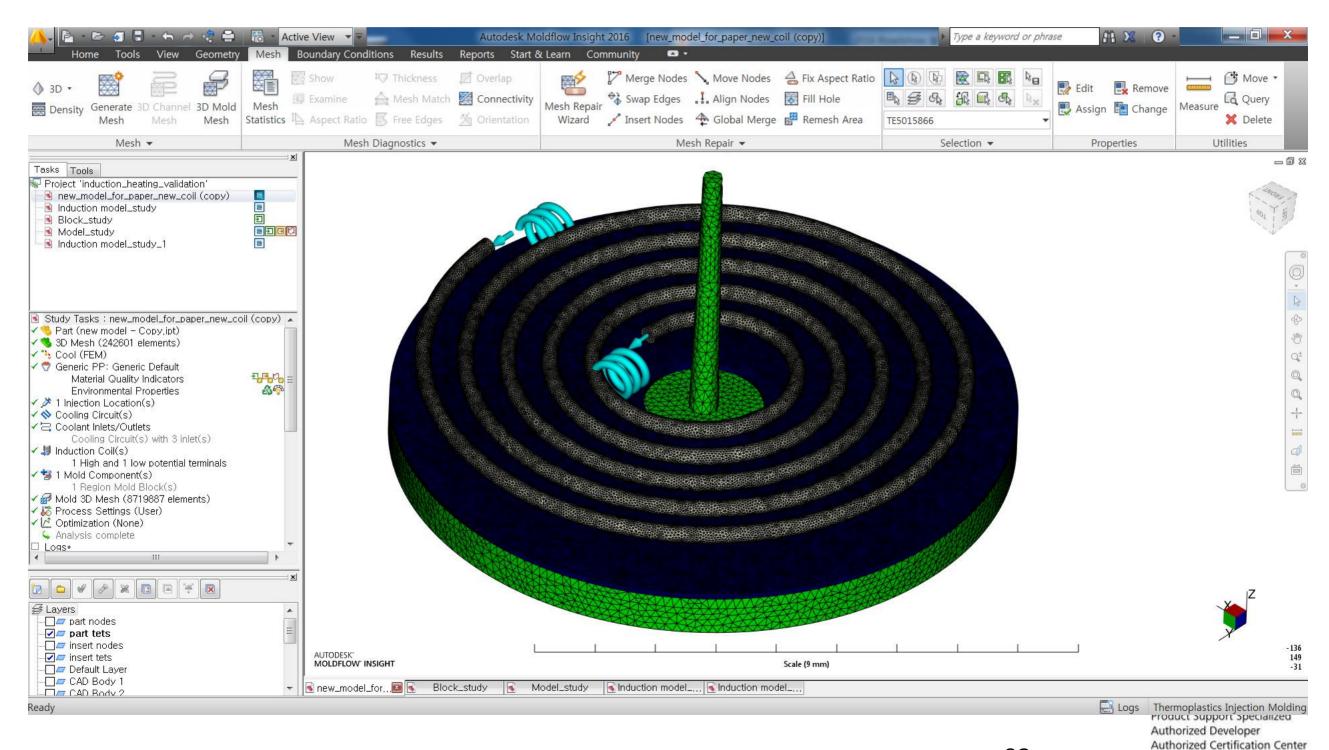


Induction Coil High/Low Potential Terminal 설정(Boundary Condition)



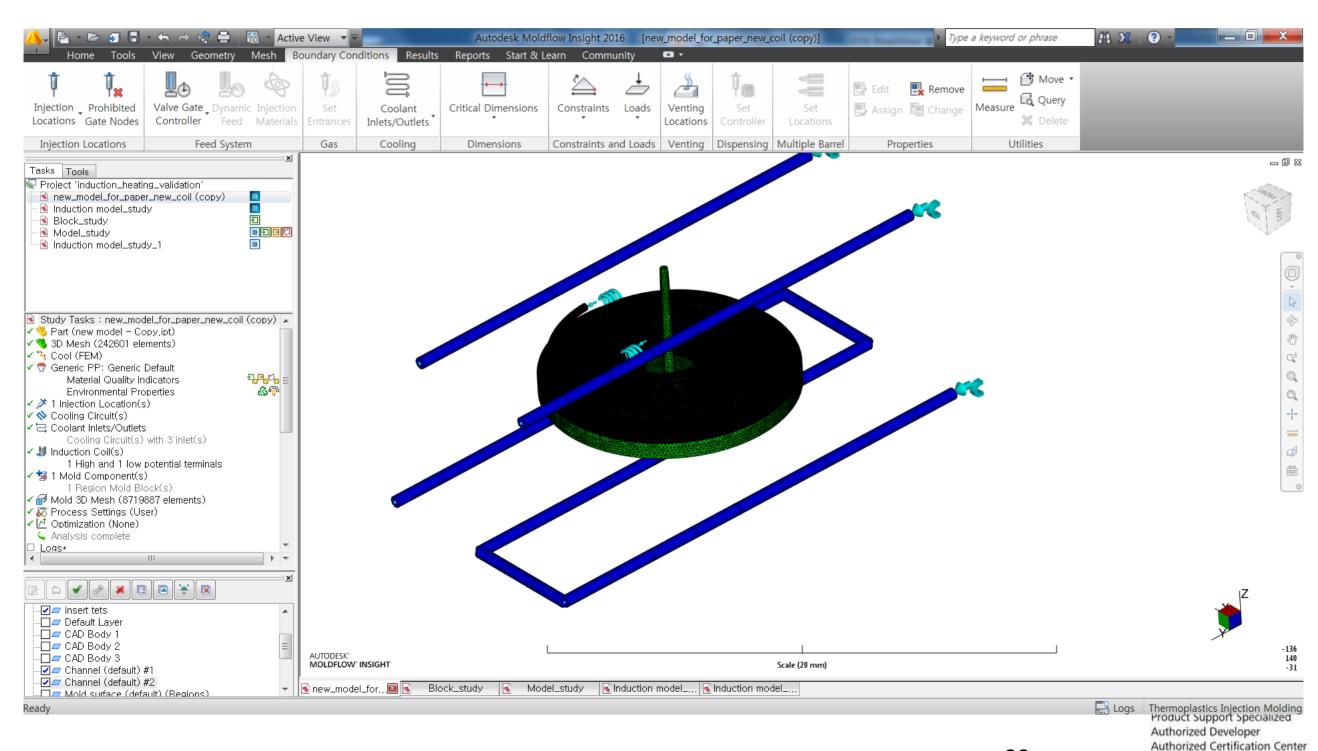


Induction Coil Mesh 생성



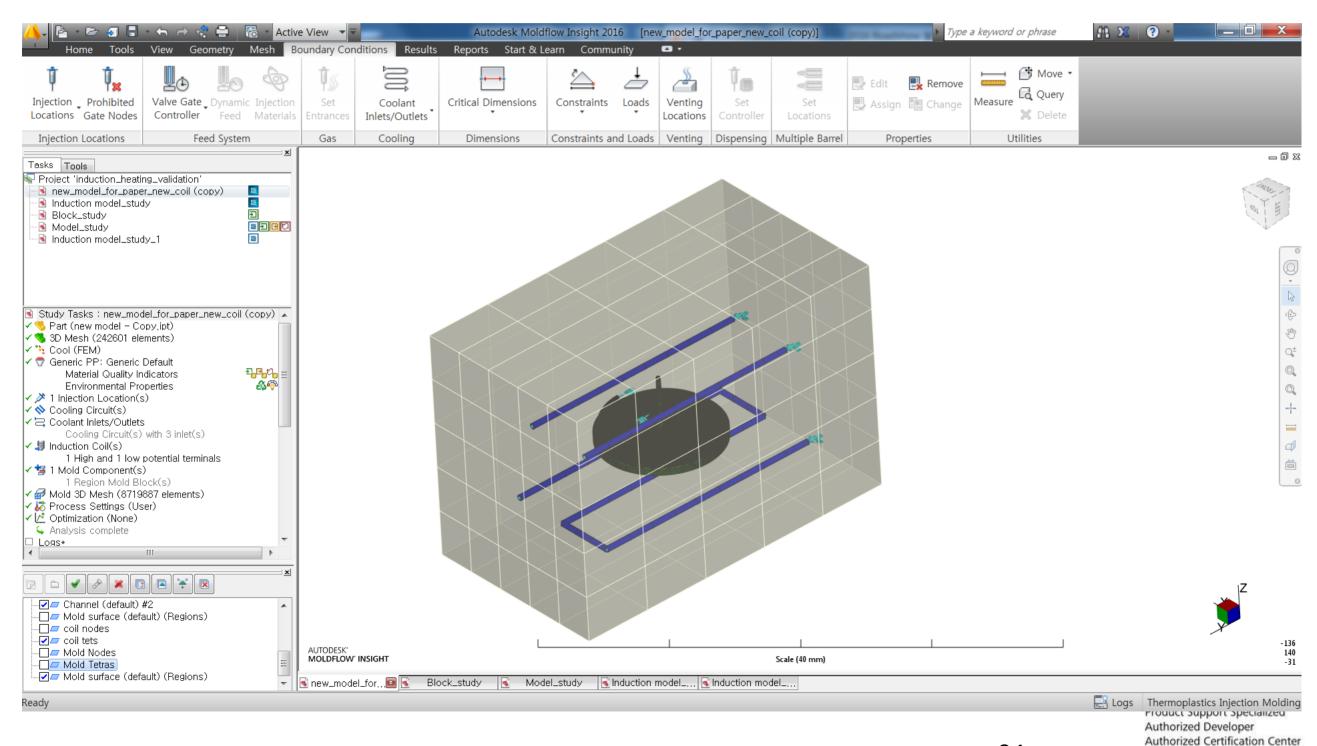


Channel Beam Mesh 생성



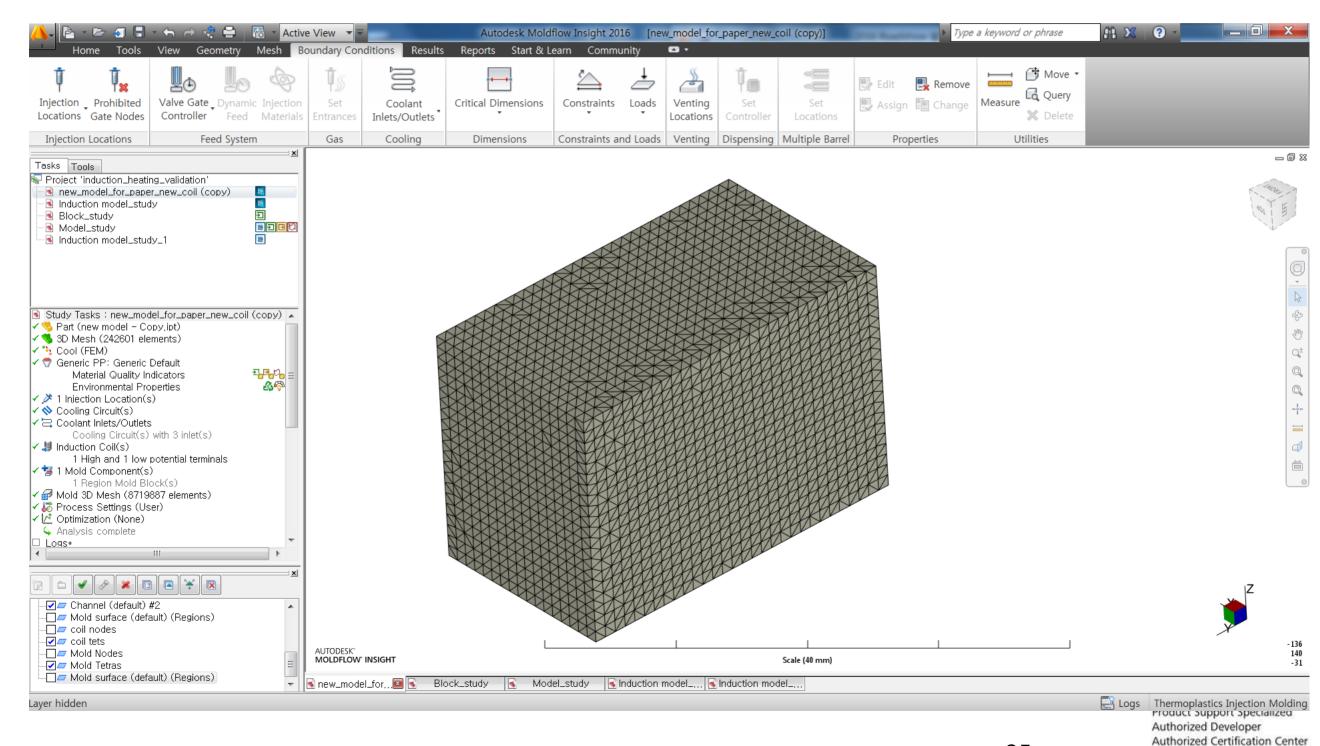


Mold Surface 생성





Mold Surface Mesh 생성



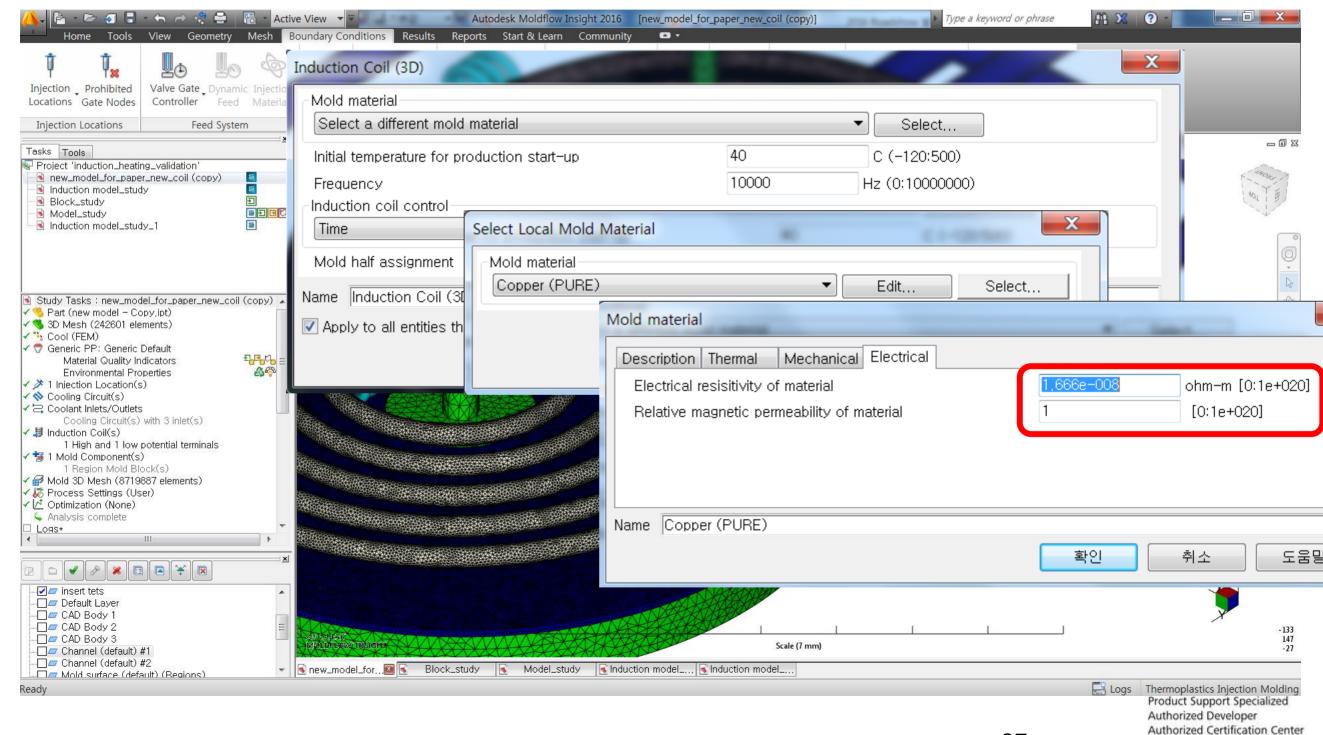


Induction Coil high potential terminal에 전류 및 전압 설정



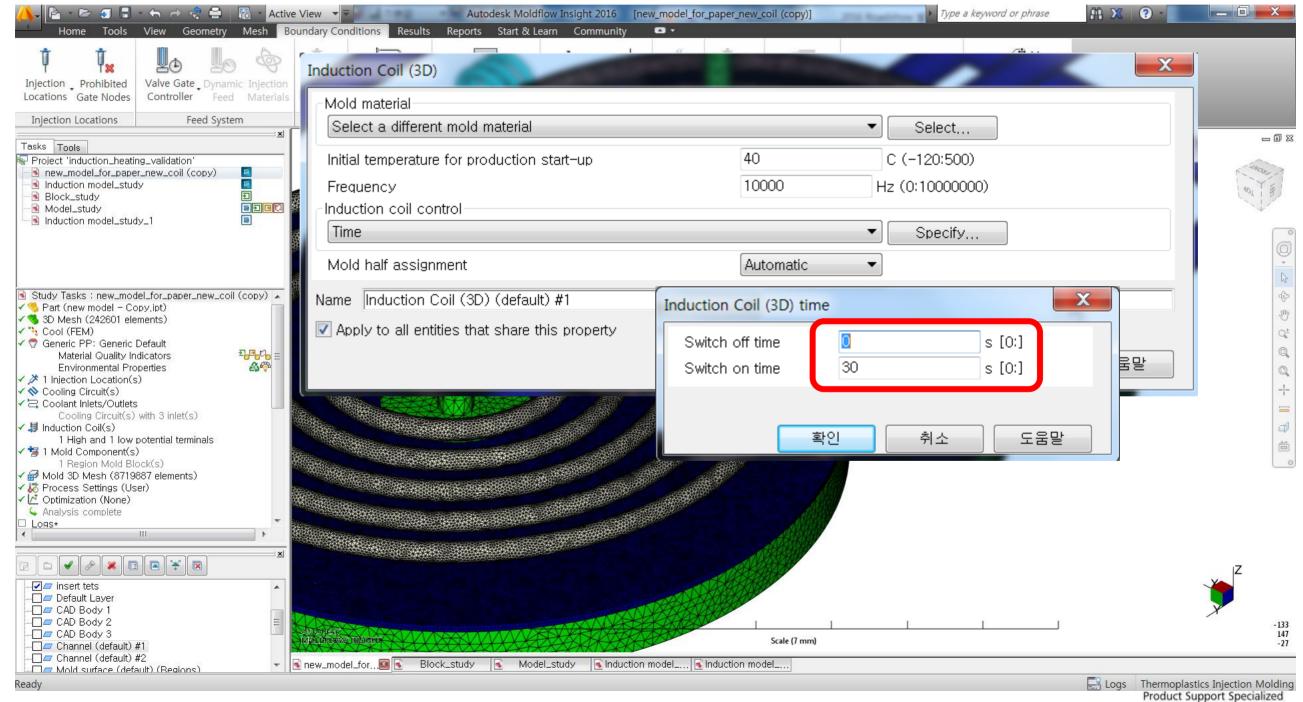


■ Induction Coil 속성 설정(Electrical- 전기저항 및 상대투자율)



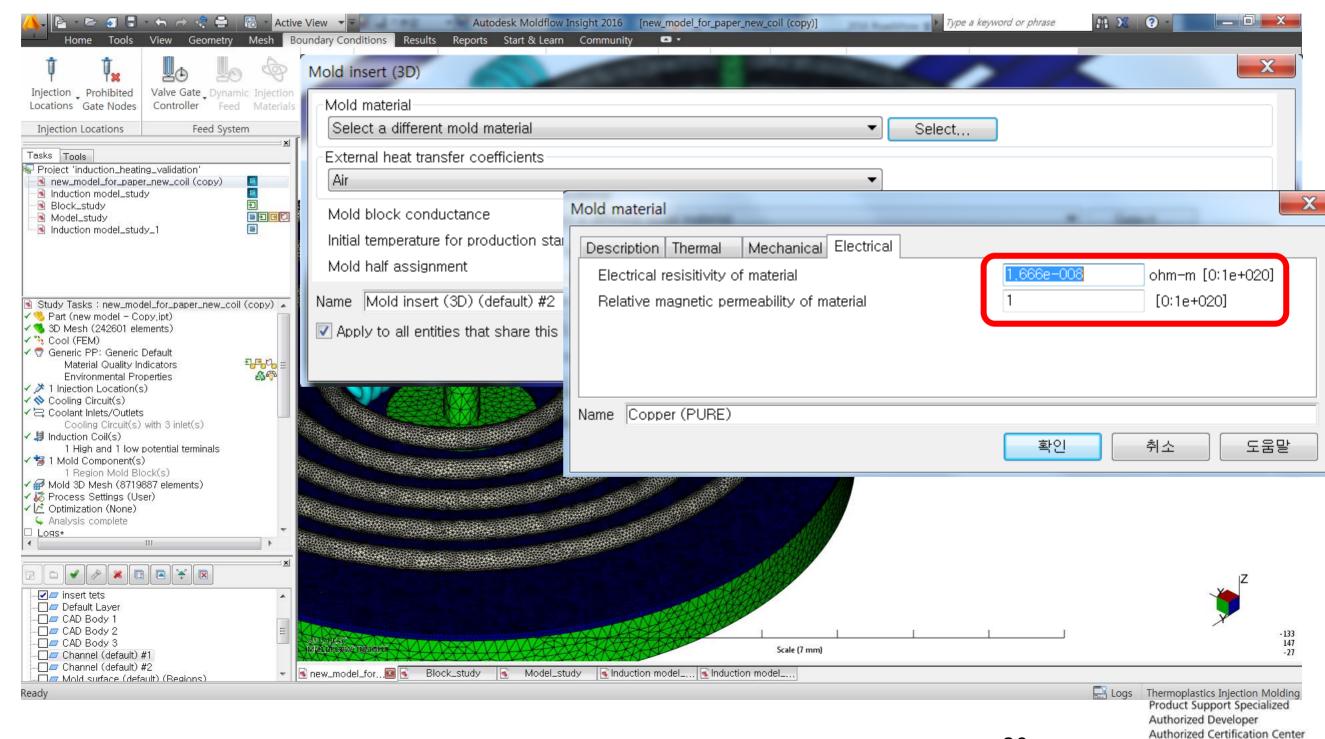


Induction Coil 속성 설정 (시간설정)



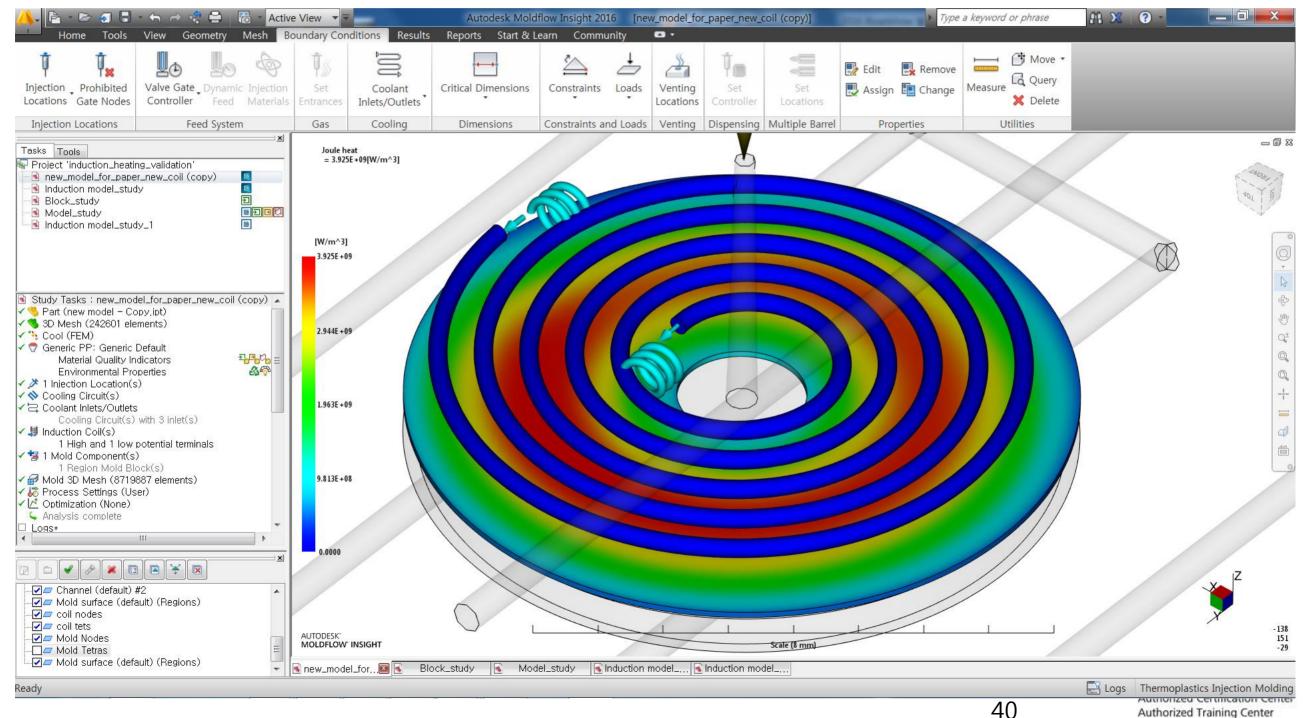


Mold Insert 속성 설정(Electrical- 전기저항 및 상대투자율)



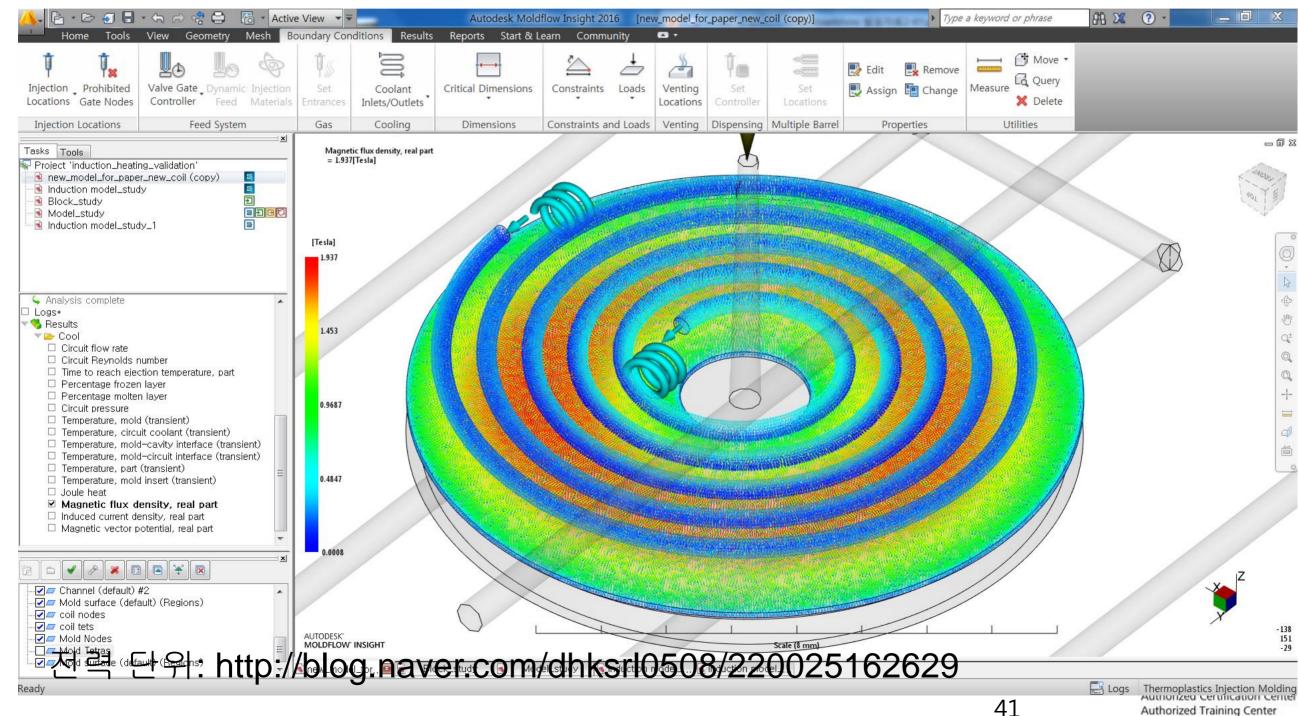


Joule heating 결과 - 단위 체적당(m³) 발생하는 전력(W) 1W=1J/s, 1J=1Nm



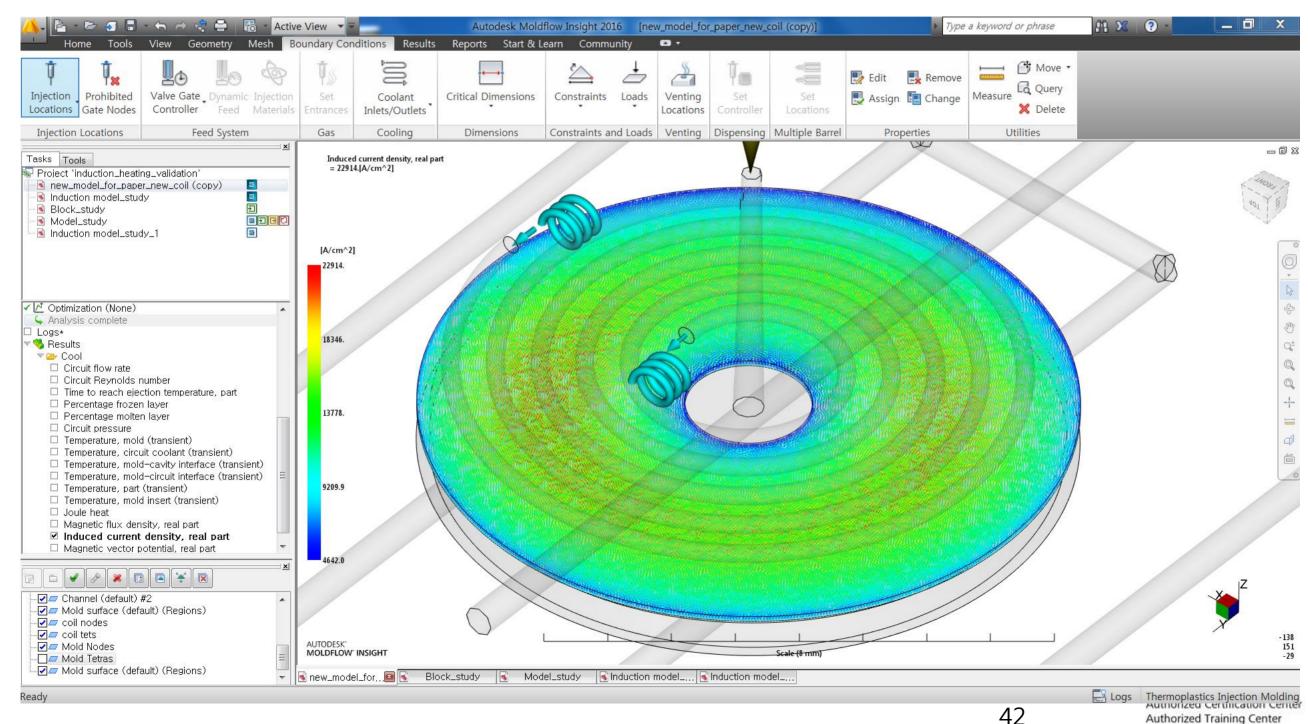


Magnetic flux density, real part – 제품에 생성되는 자속 밀도 단위 T



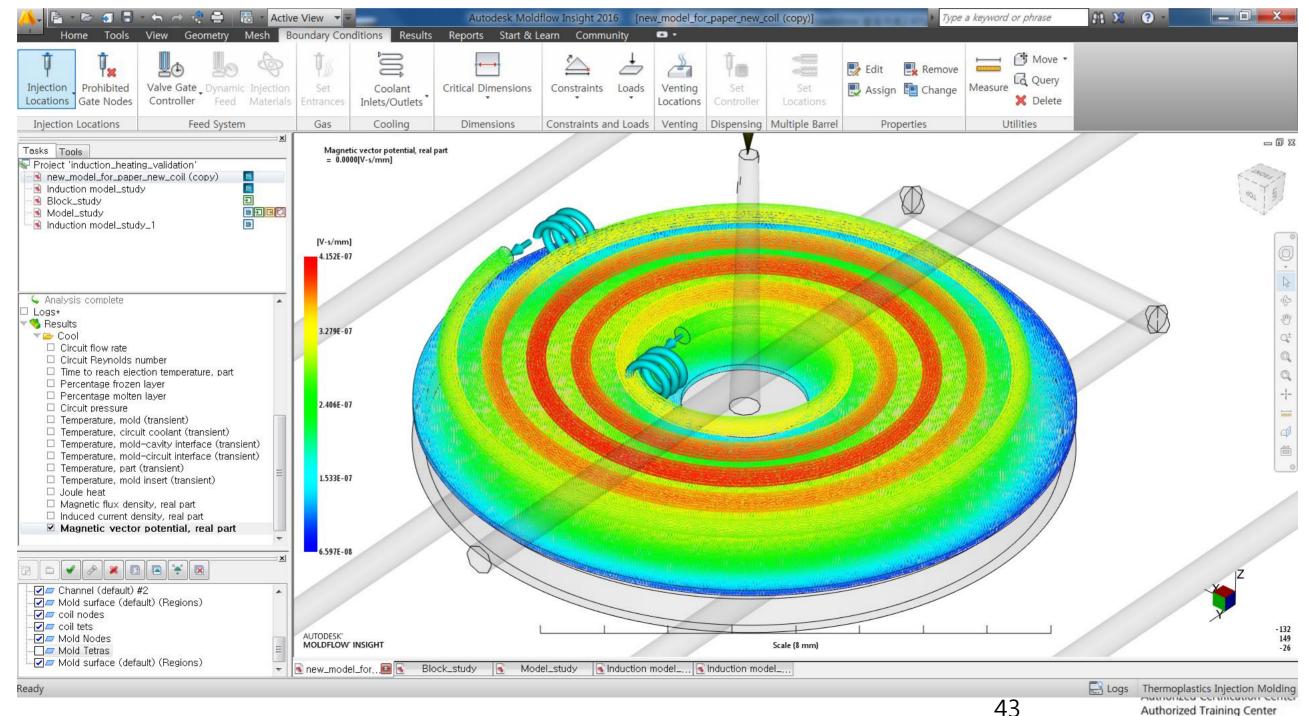


Induced current density, real part- 제품에 발생하는 유도전류 밀도 H/m=A/m





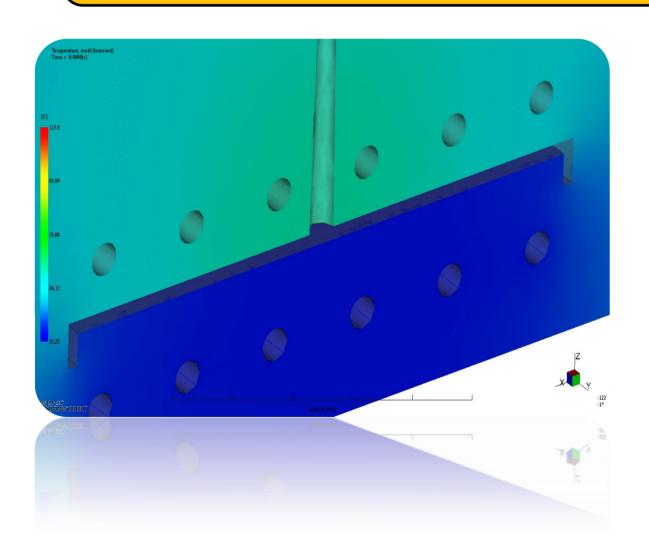
- Magnetic vector potential, real part 잠재적인 자기벡터 결과
 - Joule heating 결과를 생성시키기 위한 중간 결과로 자기장의 방향 및 크기를 확인

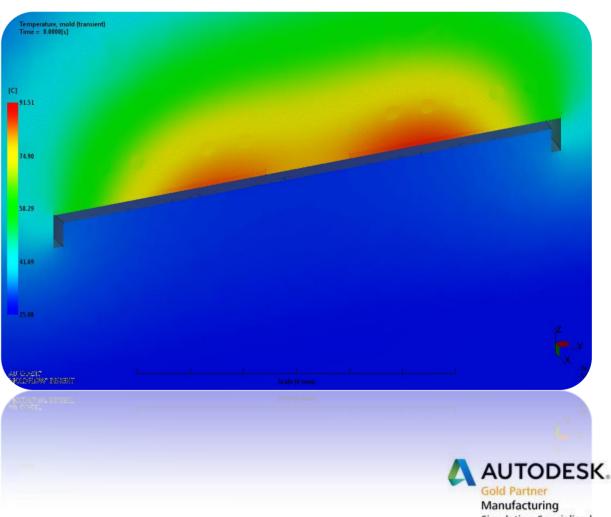




■ Temperature, mold(transient) – 금형온도 결과

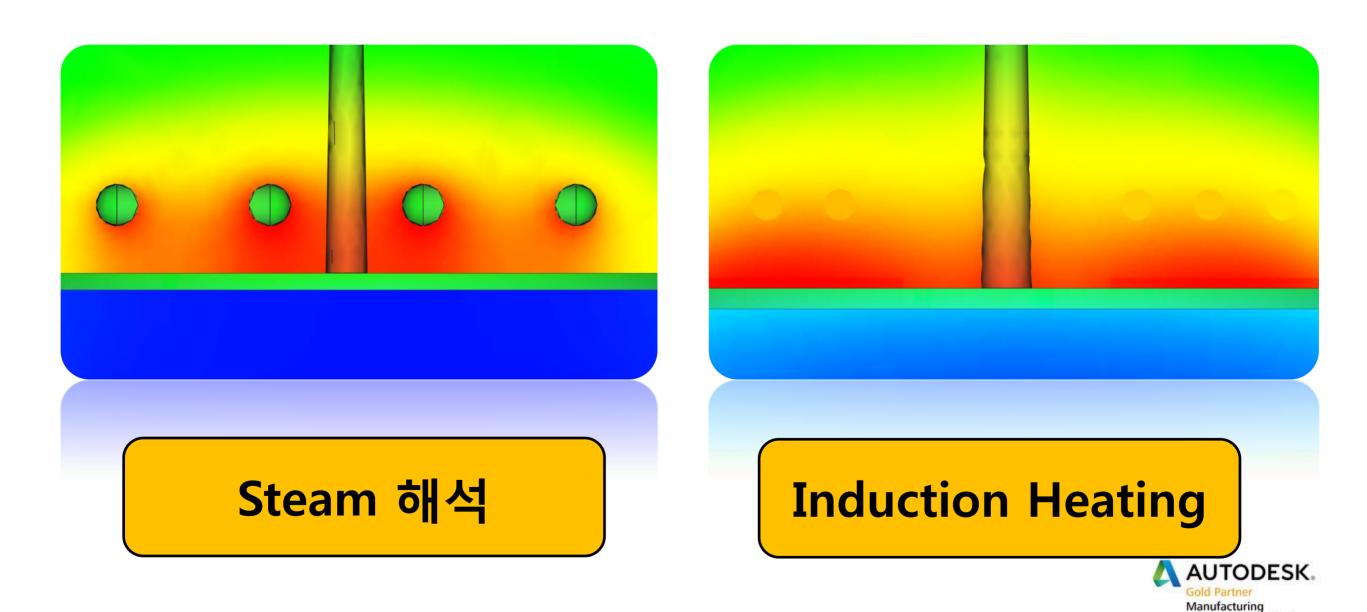
Induction Heating 결과는?







어떤 결과가 Induction Heating 일까요?



Simulation Specialized



Conclusions

- 1. Induction Heating해석을 위해서는...

 재료의 전기저항, 상대투자율, 전류or전압을 정확히 입력해야 함.
- 2. Mold Insert 의 표면에서 1st Layer의 두께는...

$$\delta = \frac{1}{\sqrt{\pi f \mu \sigma}}$$

- → 전력 주파수, 재료의 투자율, 재료의 전기 전도율을 알아야 함.
- 3. Mold Insert 의 표면 매시 사이즈는... $mesh\ size = \frac{\delta}{0.8}$ 로 정해야 한다.
- 4. Induction Heating의 장점으로...
 복잡한 형상도 균일한 가열이 가능하다.
 급속 가열이 가능하다.
 열전도에 대한 손실이 우수하다.





감사합니다

